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Neutron Transmutation Doping at JRTR to Strengthen Global Semiconductor Supply Chain for Net-Zero Emission Technologies

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RR: Jordan Research and Training Reactor (JRTR)

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❖ Summary of Progress & Conclusion

1. Semiconductor Market

(Silicon)

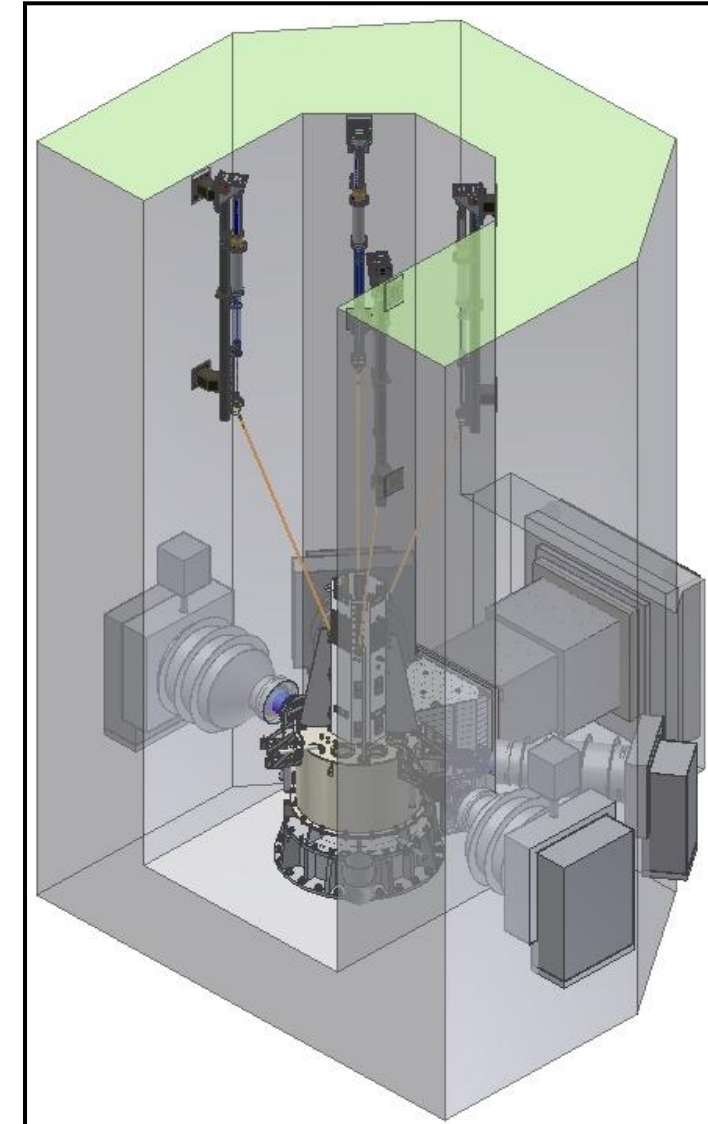
Item	Description / Status
Criticality Of Material	<ul style="list-style-type: none"> ✓ Semiconductors (Si) are critical electronic components ✓ Serve a vital role across numerous industrial sectors ✓ Especially in emerging green energy technologies using high-quality, HV devices
Why Silicon	<ul style="list-style-type: none"> ✓ Although Ge is used for various key products, NTD primarily focuses on Si ✓ N-doped NTD-Si semiconductors are still widely used ✓ Especially in high-performance, HV power devices

Item	Description / Status
Statistics And Trends	<div><div>✓ According to the Historical Billings Report (2025) of the World Semiconductor Trade Statistics (WSTS) Organization, global semiconductor sales are projected to reach ~ \$697 billion (11.2% increase from 2024) (to grow by 8.5% in 2026 to \$760.7 billion)</div><div>✓ Making semiconductors the world's fourth largest trade product (after crude oil, refined oil, and automobiles)</div><div>✓ Driven by the Logic and Memory sectors, EV, and HV-electronics (expected to be broad-based, with continued expansion across all global regions)</div><div>✓ COVID-19 chip shortages and trade tensions have exposed supply chain issues, pushing countries to seek more control over semiconductor production</div><div>✓ Hence, strengthening the global semiconductor production system is thus essential</div></div>

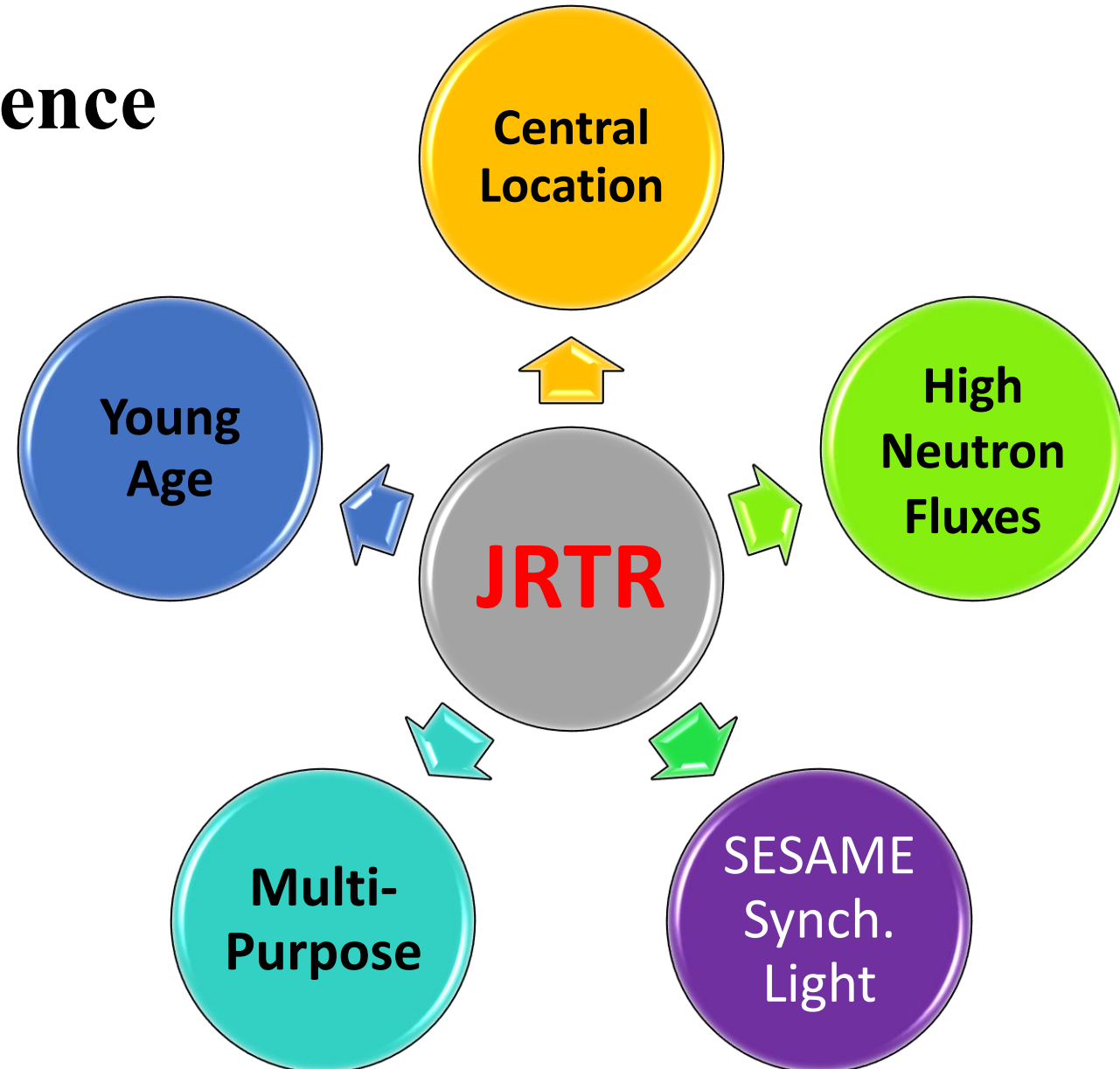
2. Introduction about JRTR

Characteristics of the JRTR

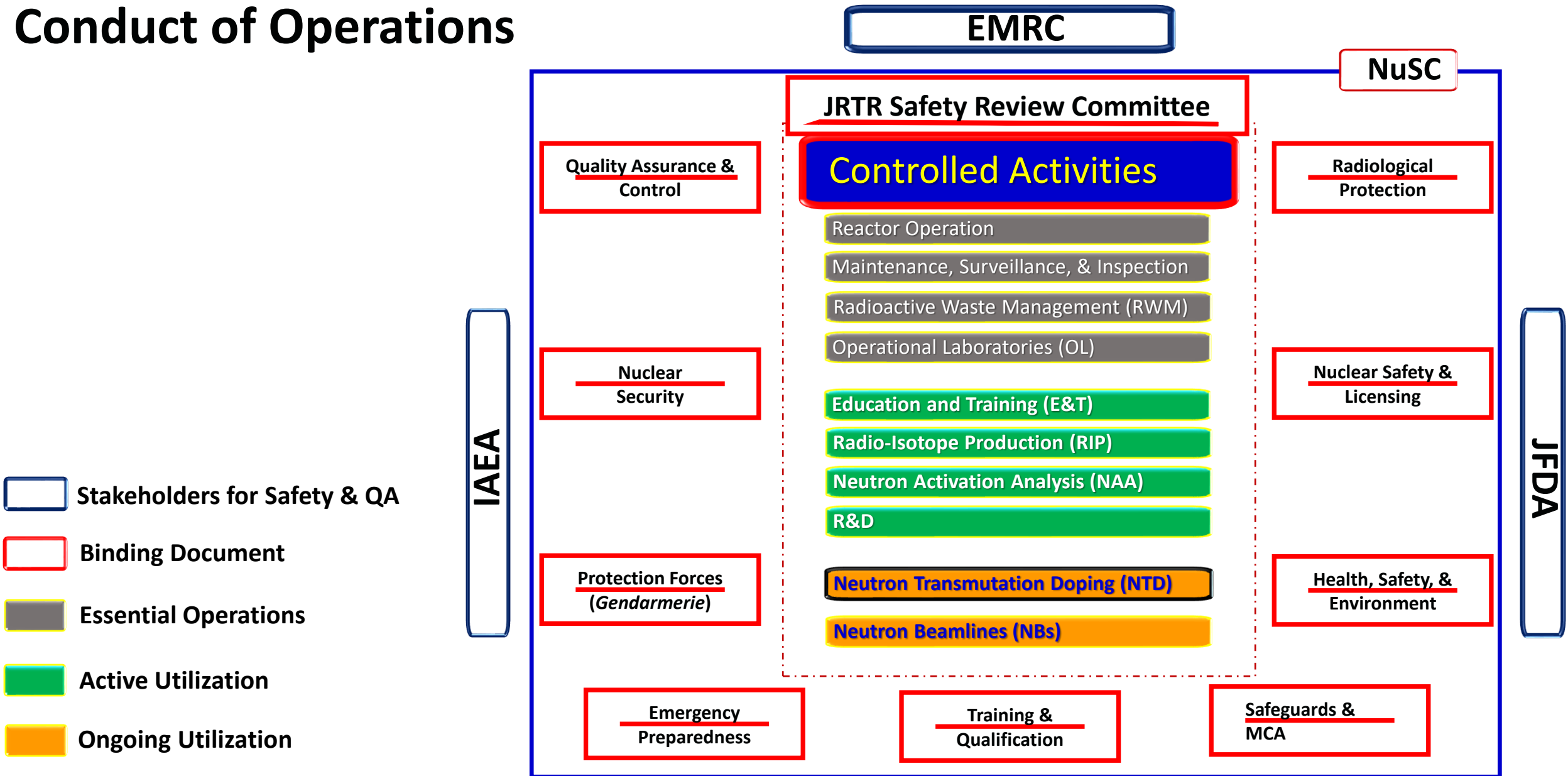
Rx. type:	Open-tank-in-pool (multi-purpose)
Thermal power (MW _{th}):	5 (upgradable to 10)
Max. Th. neutron flux (n/cm ² /s):	1.5 x 10¹⁴ → in the core (central trap) 4.0 x 10¹³ → in the reflector region (D₂O tank)
Fuel type:	Plate type, 19.75% enriched (U ₃ Si ₂ matrix)
Fuel loading:	18 FAs, 7.0 kg of U-235 , aluminum cladding
Coolant/Moderator:	Light water (demineralized H₂O)
Cooling methods:	Natural/Forced convection flow
Reflector:	Be assemblies + heavy water (D₂O)
Utilization: (multi-purpose)	<ul style="list-style-type: none"> ✓ Education & Training (E&T): (Training center + MCR Experiments) ✓ Neutron Irradiation Services (35 Vert.): (RIP, NAA, NTD... etc.) ✓ Neutron Beamline Applications (4 Horz.): (Neutron Radiography & Scattering) + 1 Th. column



Importance and Competence of the **JRTR**



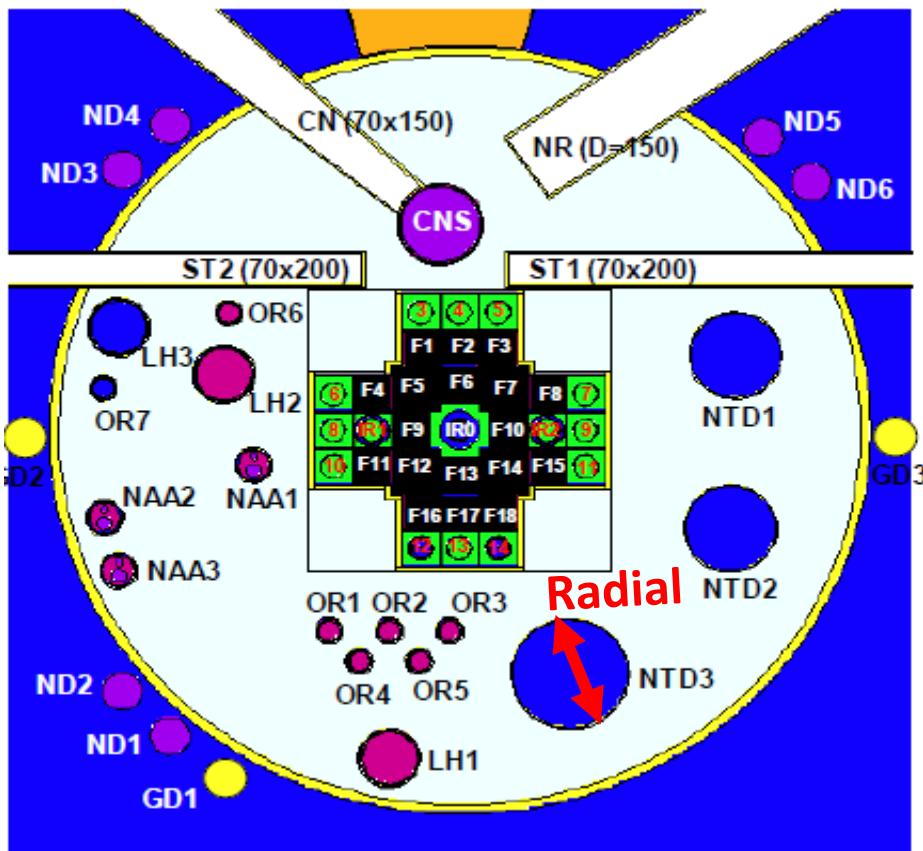
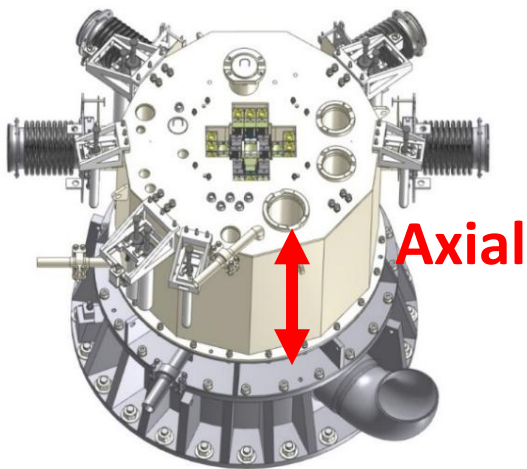
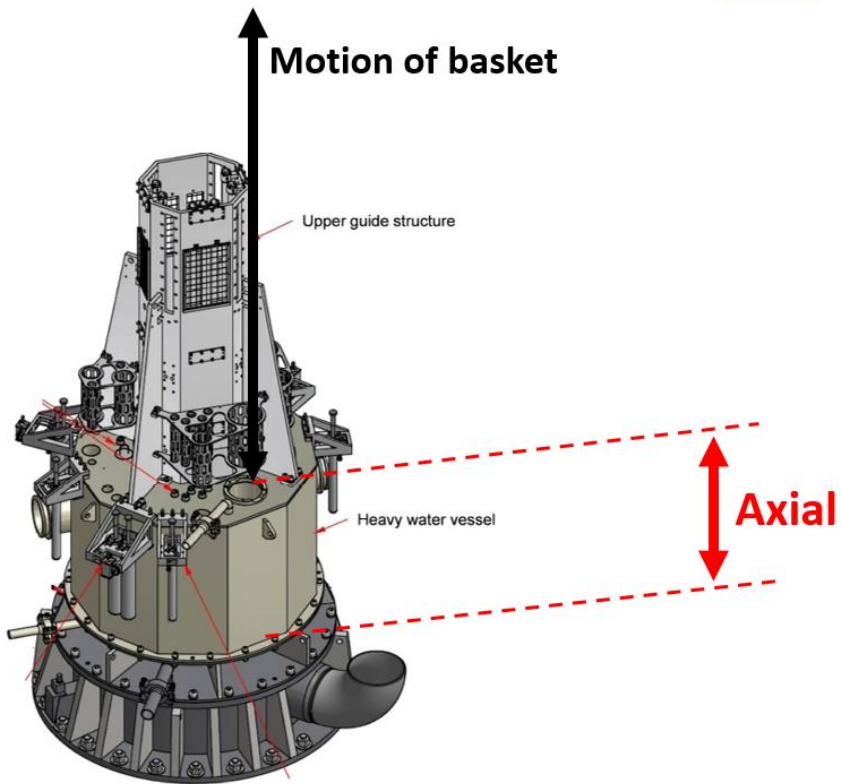
Conduct of Operations



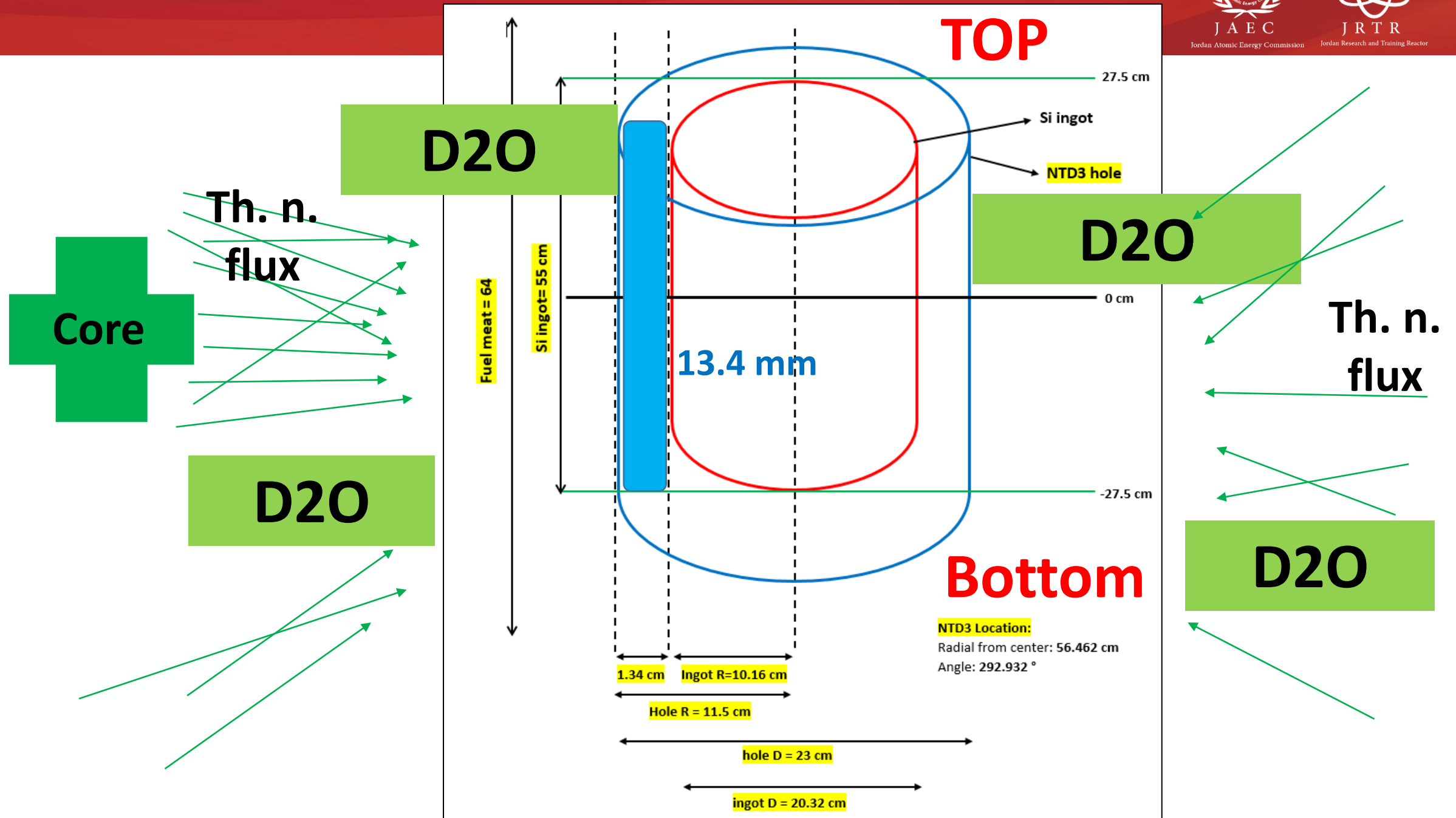
3. NTD Facility at JRTR

3.1 Design and Geometry

RPWP



Hole name & Diameter		Ingot Dia.	
NTD1	18 cm	6"	15.24 cm
NTD2	18 cm	6"	15.24 cm
NTD3	23 cm	8"	20.32 cm



3.2 Neutron Flux Characterization

Ref: FSAR, Rev.4

Table 5.5-5 Neutron Fluxes at Utilization Positions (Eq. Core, BOC)

Utilization Position	Neutron Flux (n/cm ² s)				Material in the hole
	Thermal Flux (E<0.625 eV)		Fast Flux (E>1.0 MeV)		
	Maximum	Average	Maximum	Average	
NTD1	9.8E+12	8.3E+12	3.0E+10	2.3E+10	Water
NTD2	8.9E+12	7.4E+12	3.2E+10	2.2E+10	Water
NTD3	8.4E+12	7.0E+12	5.0E+10	3.8E+10	Water

Th./fast ratio
(**Max./Max.**):

NTD1 ~ 325

NTD2 ~ 280

NTD3 ~ 170

Th./fast ratio
(**Avg./Avg.**):

NTD1 ~ 360

NTD2 ~ 335

NTD3 ~ 185

Country	RR name	ϕ_{th}/ϕ_f at NTD hole
Germany	FRM-II	1700 = $1.7 \times 10^{13} / 1.0 \times 10^{10}$
Australia	OPAL	800 = $1.6 \times 10^{13} / 2.0 \times 10^{10}$
Jordan	JRTR	> 180 = $6.9 \times 10^{12} / 3.7 \times 10^{10}$
Poland	MARIA	133 = $6.0 \times 10^{12} / 4.5 \times 10^{10}$
China	CARR	100 = $1.0 \times 10^{14} / 1.0 \times 10^{12}$
China	HFTER	4.8 = $1.2 \times 10^{14} / 0.25 \times 10^{15}$
Belgium	BR2 (SIDONIE)	27 = $5.5 \times 10^{13} / 0.2 \times 10^{10}$
Check	LVR-15	12 = $2.7 \times 10^{13} / 2.2 \times 10^{12}$
Belgium	BR2 (POSEIDON)	5.3 = $5.3 \times 10^{12} / 1.0 \times 10^{12}$
South Africa	SAFARI-1	1.6 = $1.5 \times 10^{14} / 9.3 \times 10^{13}$
China	MJTR	0.54 = $4.5 \times 10^{13} / 1.9 \times 10^{14}$
Brazil	IAE-R1.	---
Korea	HANARO	400

Most of info extracted from the IAEA-TECDOC-1681 and Valentina email

➤ Neutron Spectrum (McCARD)

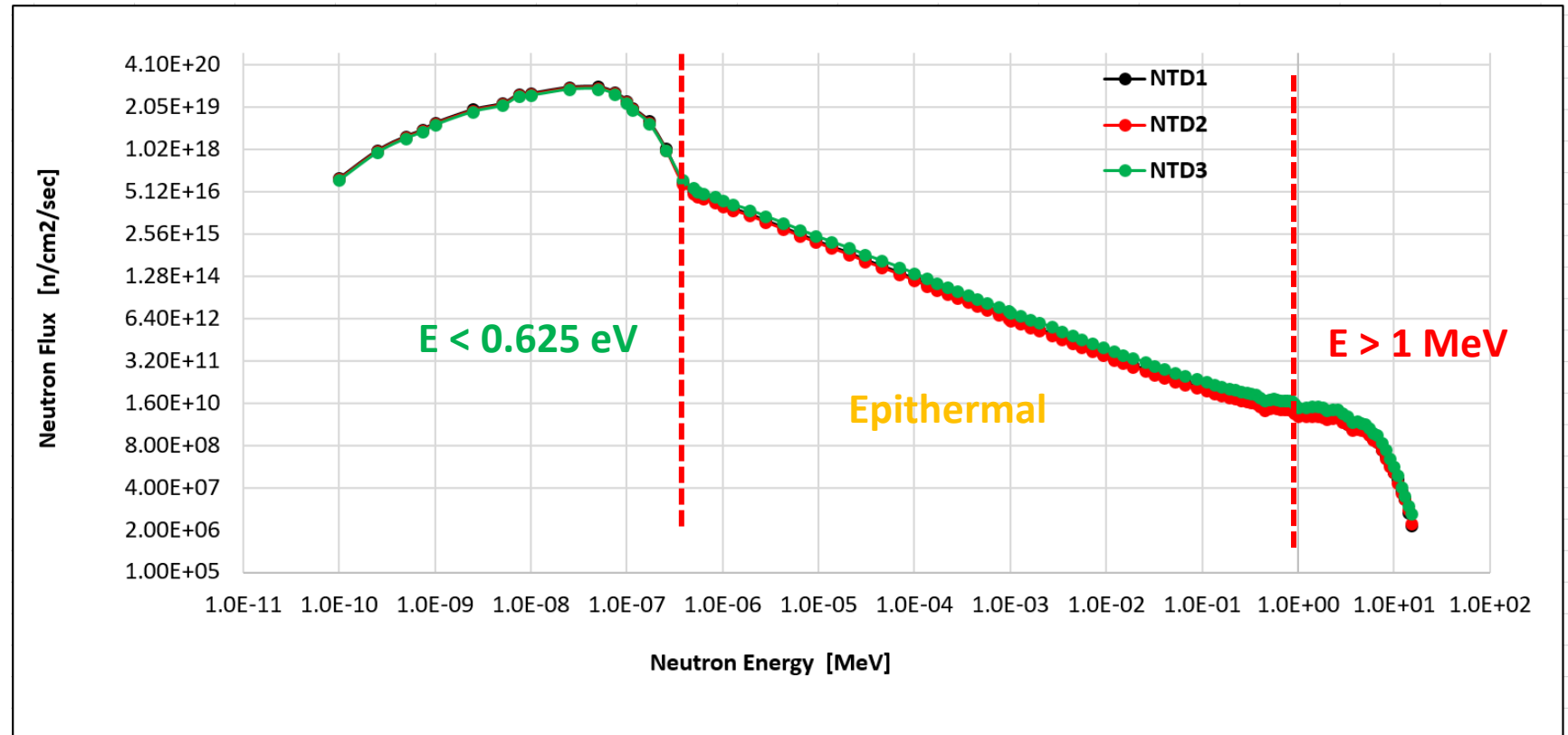


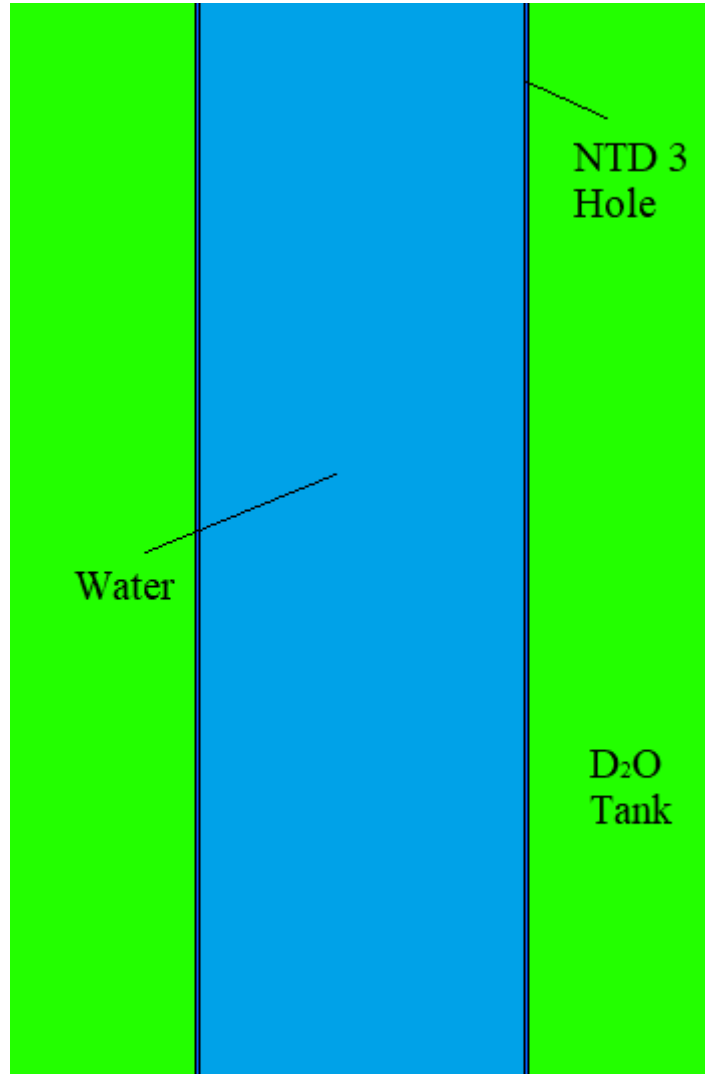
Th./fast ratio

NTD1 ~ 360

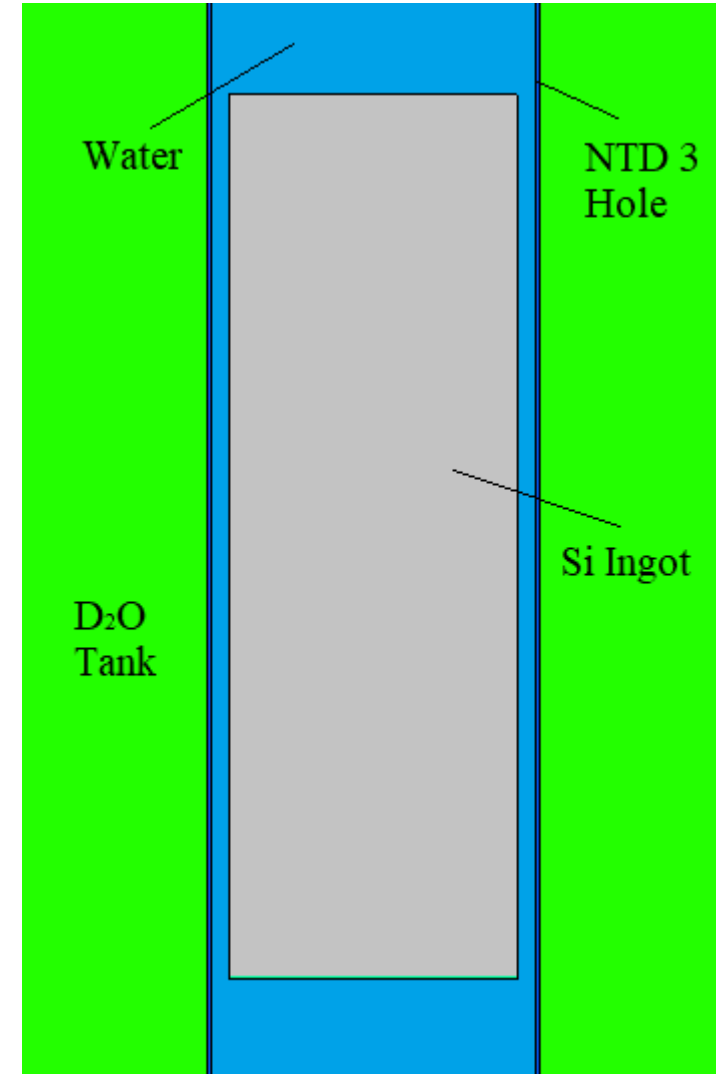
NTD2 ~ 335

NTD3 ~ 185

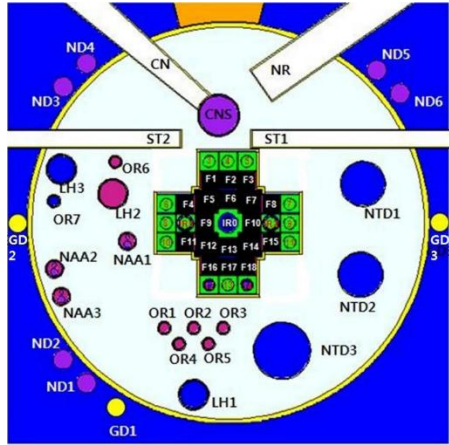




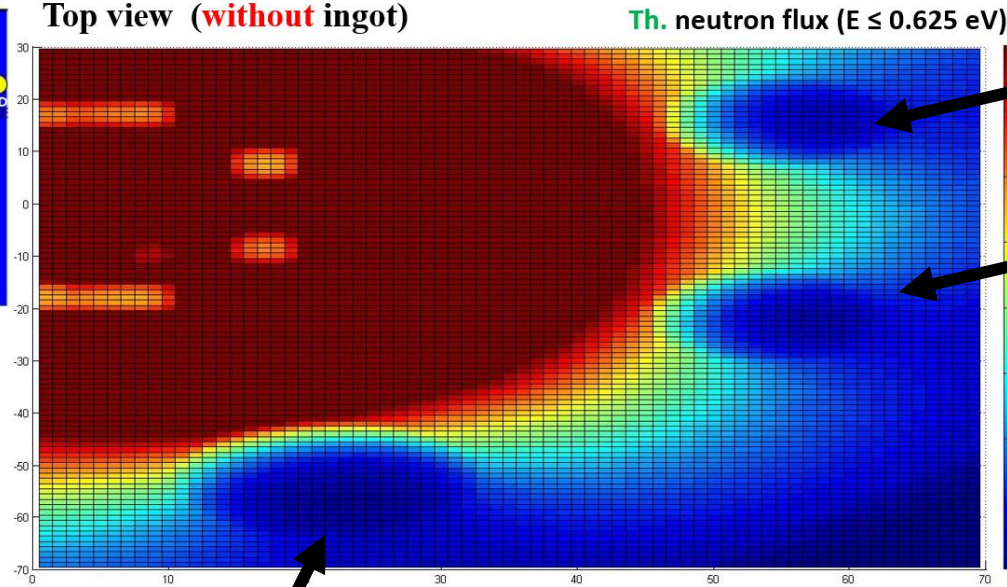
Without Si ingot



With Si ingot



Top view (**without** ingot)

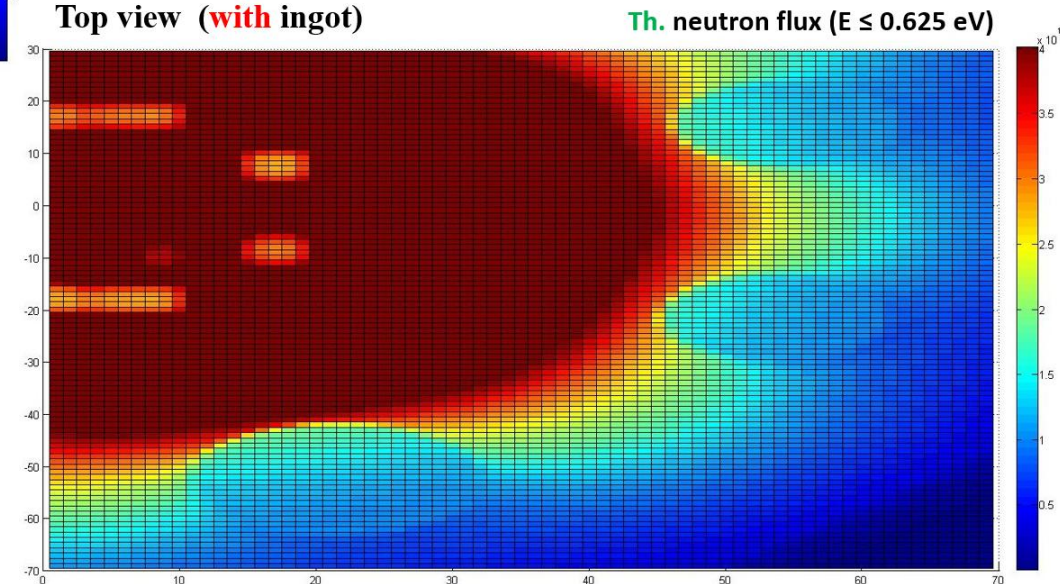


NTD#3

NTD#1

NTD#2

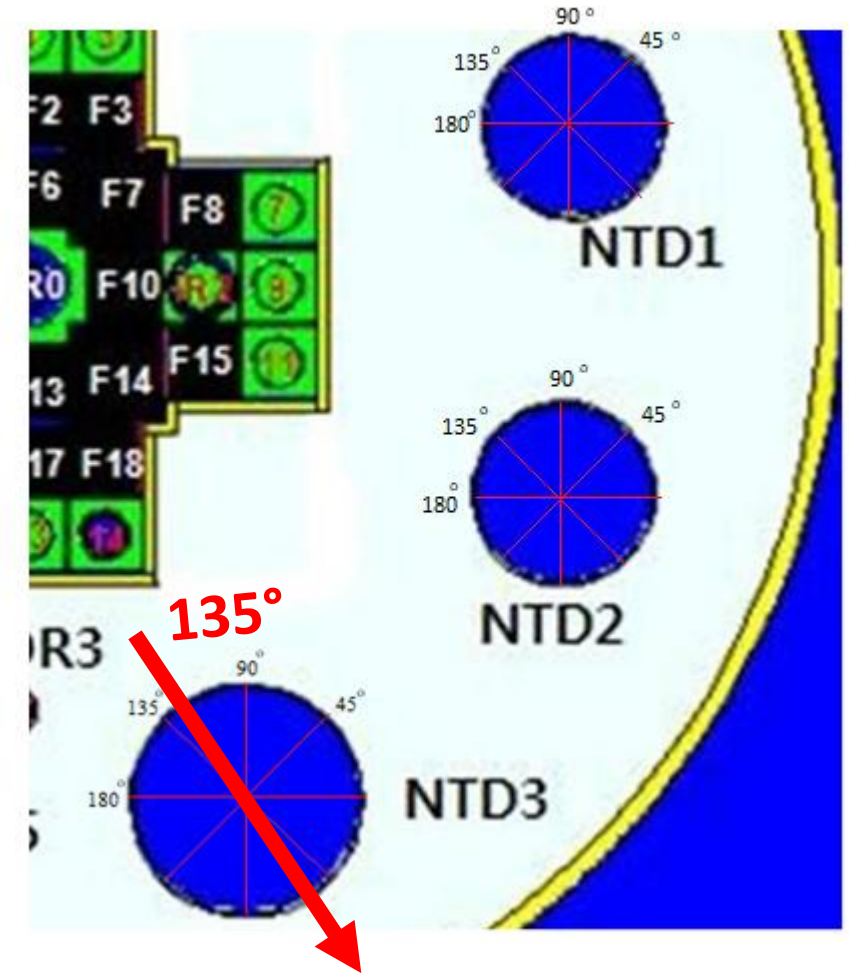
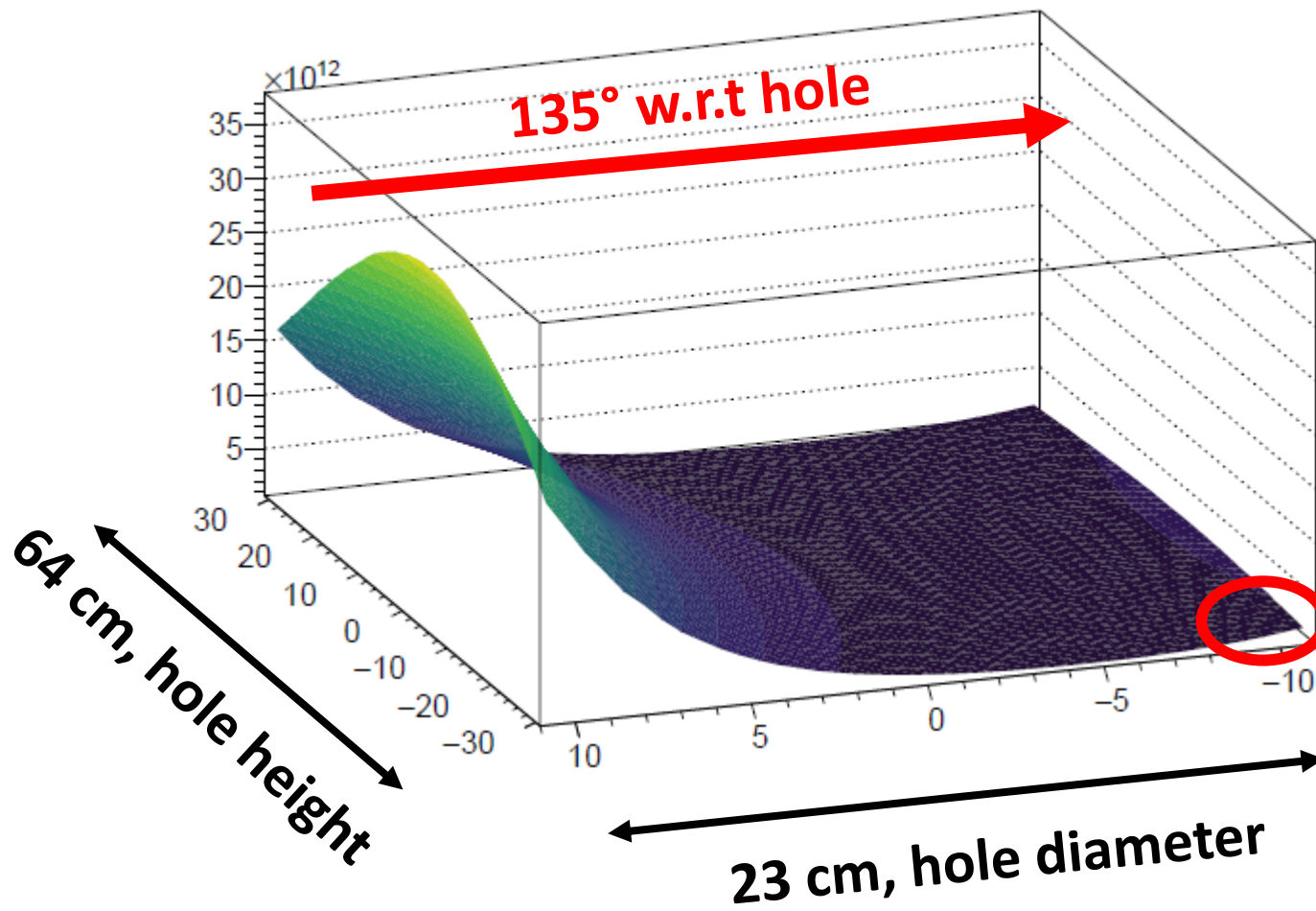
Top view (**with** ingot)



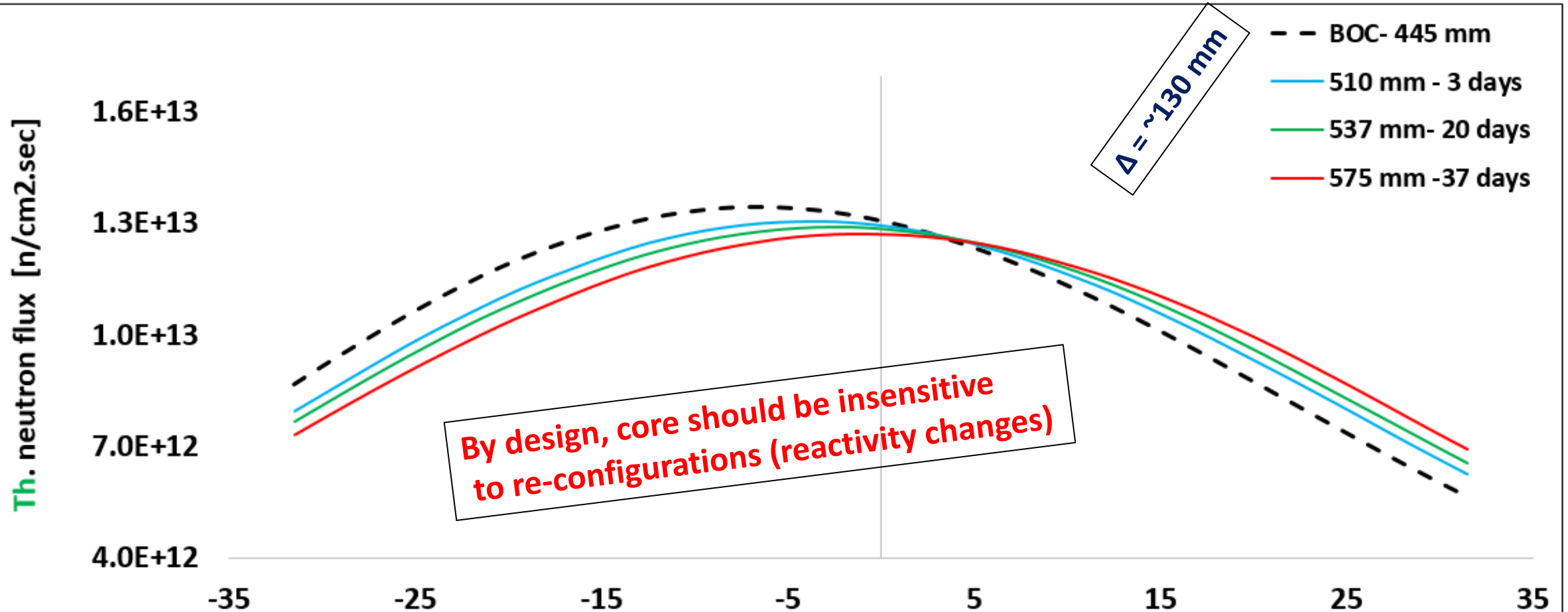
➤ Analysis:

- ✓ Thermalization due to water / silicon
- ✓ Backscattering (reflection back) effect
- ✓ Hole center angle (flux direction)
- ✓ Others

➤ Flux along the **135°** line NTD3 McCARD using Point Detectors

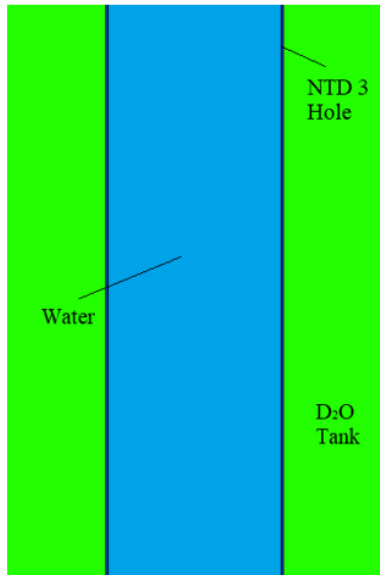


Th. neutron flux at NTD#3 at different points in time of cycle (BOC, MOC, EOC)

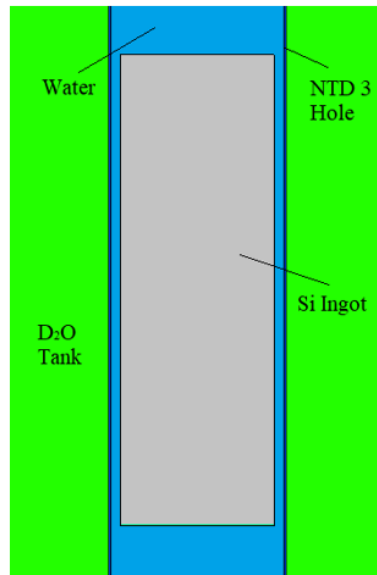


Axial [cm]

Axial Neutron Flux Distribution (McCARD)



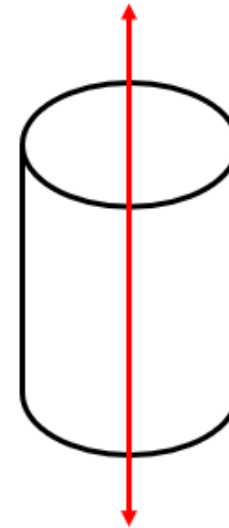
Without Si ingot



With Si ingot

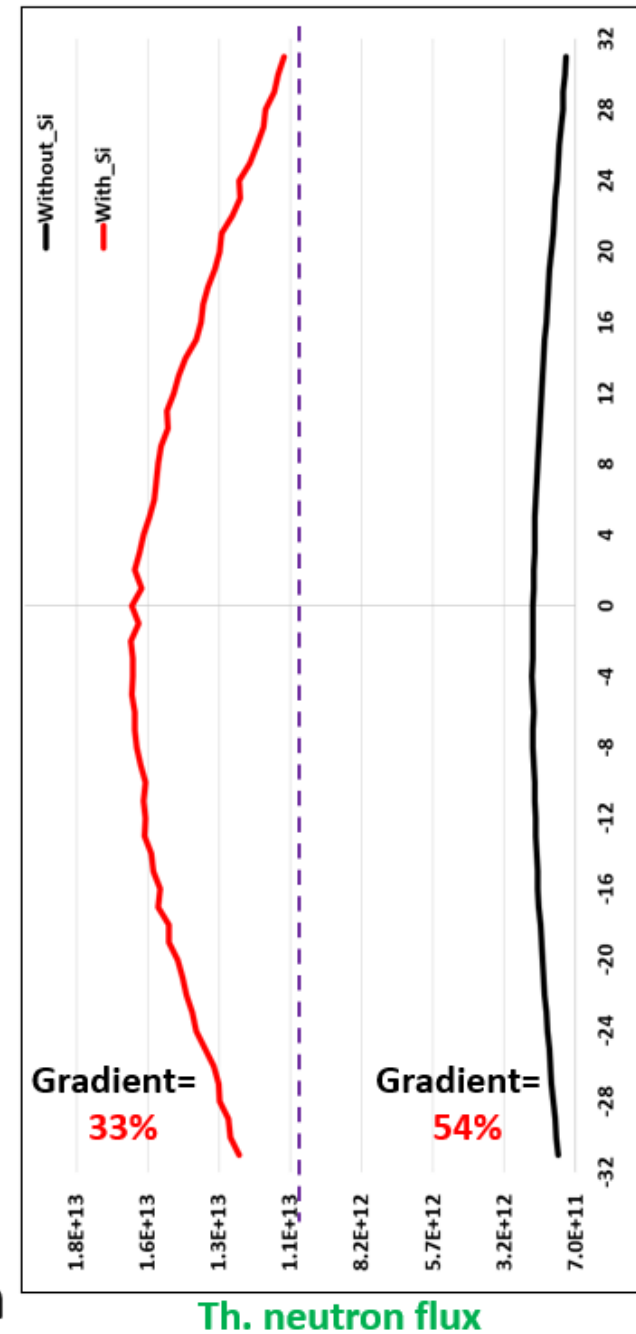
NTD3
Hole
Central
Axial Line
 $x = 220$
 $Y = -520$
 $Z = -310 \sim 310$

$\theta = \text{constant}$
 $r = 0$



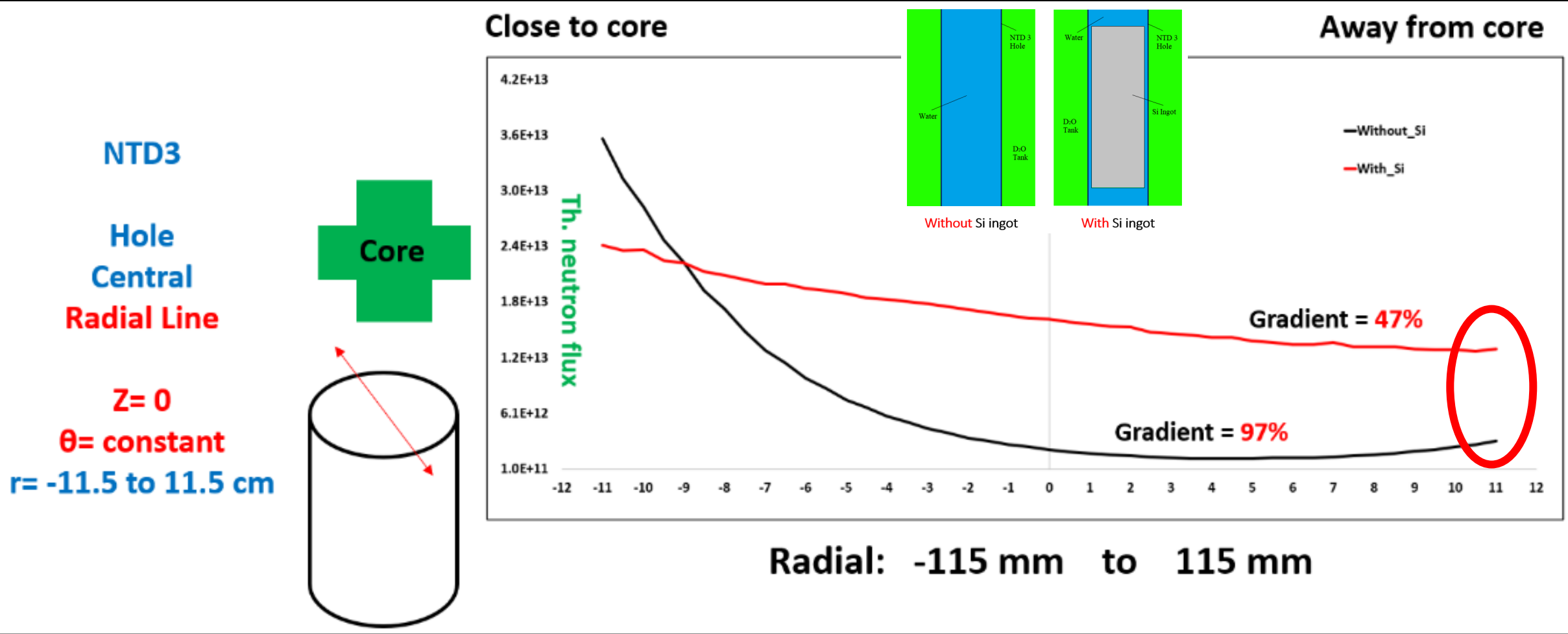
Bottom

TOP



Axial: -310 mm to 310 mm

Radial Neutron Flux Distribution (McCARD)



3.4 Doping Uniformity Control

Hole: silicon ingot
Gap: water with screen

Actual configuration

Optimum doping **uniformity** across
all ingot volume (**gradients**)

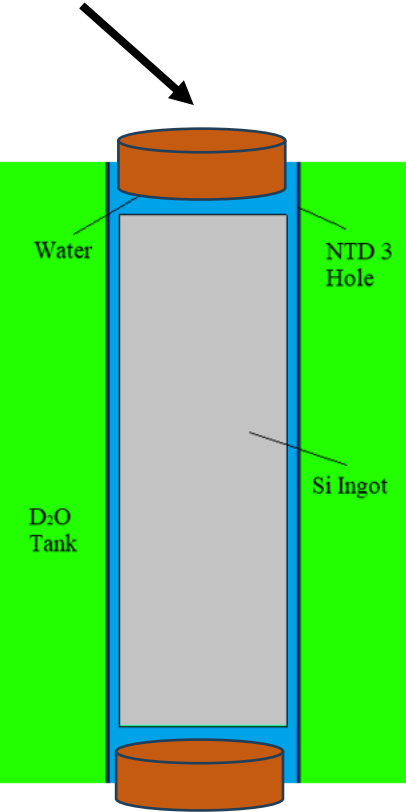
Axial Uniformity

Screen

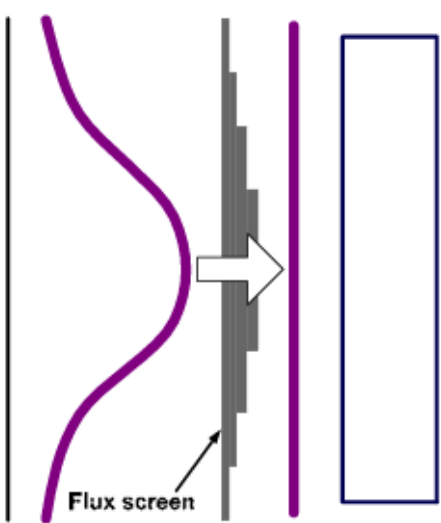
Radial Uniformity

Rotate

Top reflector



Bottom reflector



Type of Ingot	Type of flattening Filter (screen)	NTD Hole	Type of Reflector (top & bottom of ingot)	Max. Th. Flux [n.cm ⁻² .s ⁻¹]	Avg. Th. Flux [n.cm ⁻² .s ⁻¹]
Si	Al sheet + Water = 13.4 mm Gap	NTD3	Aluminum	1.39E+13	1.28E+13
			Graphite	1.43E+13	1.34E+13
			Silicon	1.40E+13	1.30E+13
			Water	1.41E+13	1.30E+13

3.5 Irradiation Capacity of Si ingots

(Estimation of Annual Production)

Constants

- Si density = 2.329 g/cm³
- Si abundance = 3.0782 %
- Si-30 Molar Mass [g/mole] = 29.97377
- Si-30 Th. capture-XS = 107 mb
- Electron mobility, μ_e (@ 300K) = 1350
- Electron charge, q_e = 1.602E-19 Coulomb

Assumptions

- Calc. fluxes using Monte Carlo Codes
- Effect of initial resistivity was subtracted
- Effective holes height = 50~55 cm
- Full Op. days = 150~200 / year

NTD Facility

- Height & Diameter for:
 - NTD1,2,3
Holes, batches (ingots)

Ingot (14-Si-30)				
Silicon bulk density [g/cm³]	rho	2.329		the drift m
Si-ingot volume [cm³]	V	17827.06		
Starting material amount (natural pure silicon)	ingots mass [g]	41519.23	41.52 kg	
Natural abundance of Si-30	θ	0.030872		
Starting material amount	Si-30 mass [g]	1281.78	1.28 kg	Irr. calibration c relationship bet
Avog. # [1/mol]	N_Avog.	6.022E+23		
M[gram/mol or [amu]] for parent nuclide	M [g/mol]	29.97377		
the Si ingots (2 or 3 in a batch of 60 cm)	No [#]	2.58E+25		Parent
the Si ingots (2 or 3 in a batch of 60 cm)	No [# /cm³]	1.445E+21	1.445E+21 [# /cm³]	
				Irr. ca
Given initial resistivity	pi [Ω.cm]	4000	this indicates No,p [# /cm³] to be subtracted (less time)=	1.156E+12
Required final resistivity	pf [Ω.cm]	200	this requires net Nact. [# /cm³] to be =	2.20E+13
Thermal neutron capture cross-section of Si-30	σc [cm²]	1.07E-25		
Thermal neutron Flux @ NTD3	φth [n/cm²/sec]	7.00E+12		
Irradiation time	ta [s]	20299.34		
Irradiation time assuming no initial dopnats	ta [hr]	5.6		
Irradiation time (without initial dopnats effects)	ta [hr]	5.64	338 min	
Neutron Fluence (Neutron Dose) @ NTD3		1.42E+17		
Neutron Fluence (Neutron Dose) @ NTD3	φt [n/cm²]			
Neutron Fluence (Neutron Dose) @ NTD3				
Rel. Err. [%]	RPE [%]	-100%		
		-100%		
Irradiation time	ta [sec]	20299.34		
Irradiation time	ta [hr]	5.64		



IAEA
International Atomic Energy Agency
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MiscellaneousMetadata-only

Estimation of Future Demand for Neutron-Transmutation-Doped Silicon Caused by Development of Hybrid Electric Vehicle

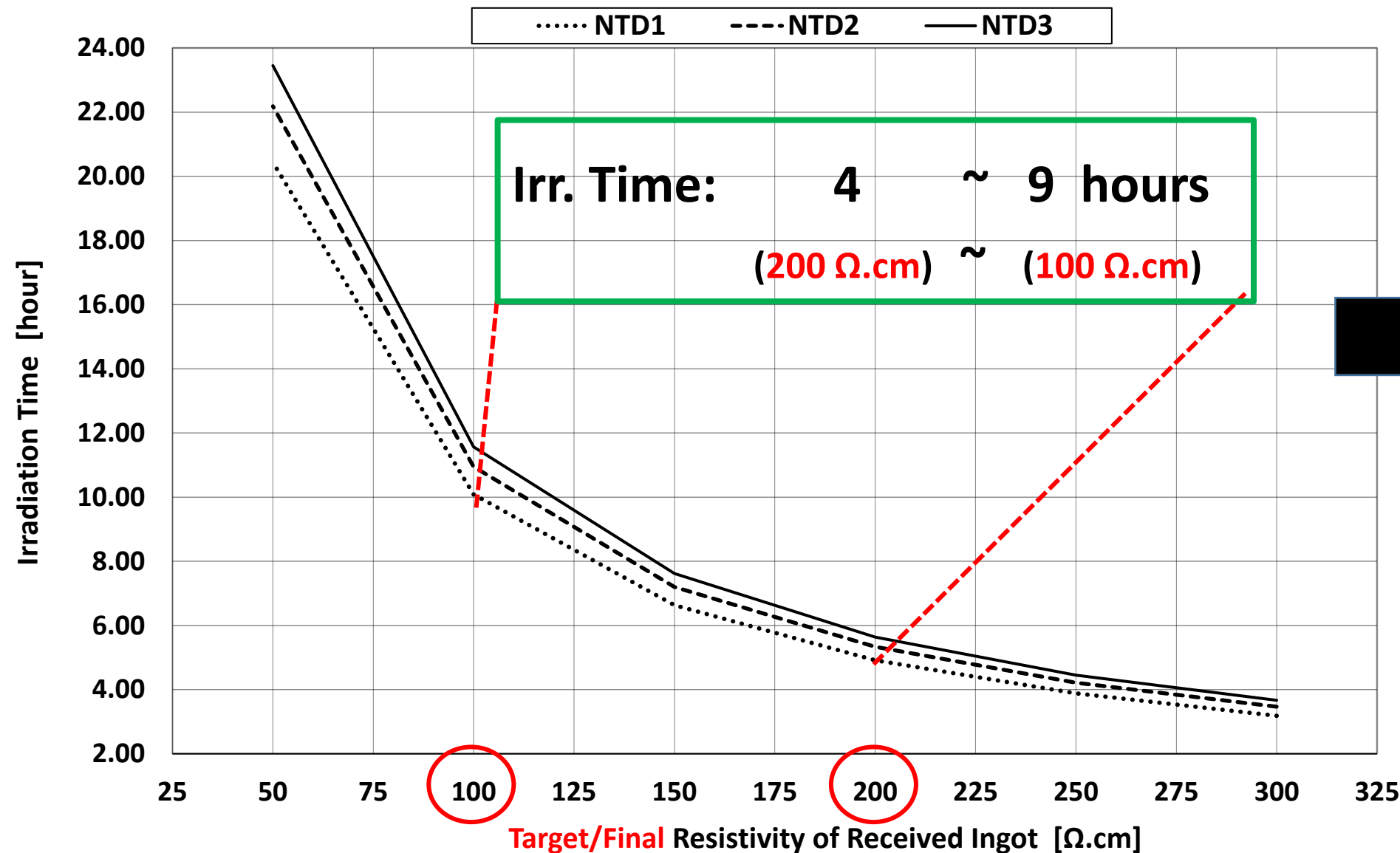
Kim, Myong Seop¹; Park, Sang Jun¹

Hide affiliations

1. Korea Atomic Energy Research Institute, Daejeon (Korea, Republic of)



Batch Irradiaiotn Time Chart of 4000 Ω .cm Initial Silicon Ingots



Tons ?

JORDAN RESEARCH AND TRAINING REACTOR		
Country	RR name	Annual Capacity (t)
Germany	FRM-II	15
Australia	OPAL	25
Jordan	JRTR	47.8 max
Poland	MARIA	15.7
China	CARR	50
China	HFTER	10
Belgium	BR2 (SIDONIE)	15
Check	LVR-15	1.5
Belgium	BR2 (POSEIDON)	45
South Africa	SAFARI-1	20
China	MJTR	20
Brazil	IAE-R1.	1.2
Korea	HANARO	20

Irr. Time:
5.5 ~ 7.5 hours

<div>Irr. Time: 5.5 ~ 7.5 hours</div>	Initial resistivity [Ω .cm]	5000	
	Target resistivity [Ω .cm]	150	
	Irradiation time per 50cm batch [min]		
	NTD1	NTD2	NTD3
FSAR (average flux, water medium, without screen, without graphite)	8.300E+12	7.400E+12	7.000E+12
	388	436	461
McCARD (min flux, silicon medium, without screen, without graphite)	9.662E+12	9.002E+12	9.277E+12
	334	358	348

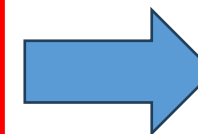
E.g.: 150 days, 6", 6", 8"
150 $\Omega \cdot \text{cm}$ → **33 ton**

E.g.: 150 days, 6", 6", 8"
200 $\Omega \cdot \text{cm}$ → **40 ton**

E.g.: 200 days, 6", 6", 8"
150 $\Omega \cdot \text{cm}$ → **44 ton**

E.g.: 200 days, 6", 6", 8"
200 $\Omega \cdot \text{cm}$ → **50 ton**

Production [ton/year]:
up to 50~55
(depends on
resistivity, Dia., and operation days)



**Under conservative
operation conditions:**
150 FPD,
100% 8" & 30% 6"
23 tons

4. Financial Considerations

Item	Description / Status / Plan / Goal
2025 Demand	<ul style="list-style-type: none"> ✓ Larger-diameter ingots (5", 6", and especially 8") has increased ✓ Driven by EV and HV-electronics markets
Key RR Suppliers	<ul style="list-style-type: none"> ✓ OPAL (Australia), HANARO (S. Korea), and BR2 (Belgium) can process these sizes ✓ But overall supply still falls short of projected needs
Irradiation Service Pricing	<ul style="list-style-type: none"> ✓ Negotiated case by case ✓ Commands a premium due to NTD's superior resistivity uniformity
Contracting	<ul style="list-style-type: none"> ✓ International contractors will be invited to bid on design, construction, and commissioning

Item	Description / Status / Plan / Goal
Project Timeline	<ul style="list-style-type: none"> ✓ A 2-year design and installation phase // A 20-year operations phase ✓ All statutory levies and taxes incorporated into the capital budget
Production Scenario	<ul style="list-style-type: none"> ✓ Conservative conditions: (150 FPDs/year, three holes in use, res. 4000 to 150) ✓ The facility expects to process roughly 20–25 tons of NTD-Si annually
Running Expenses	<ul style="list-style-type: none"> ✓ Maintenance, staffing, and fuel, are projected to grow modestly over time ✓ But remain predictable
Revenue Assumptions	<ul style="list-style-type: none"> ✓ Align with premium NTD service rates ✓ Adjusted for ingot size and resistivity ✓ The facility can cover costs and generate sustainable returns
Overall Plan	<ul style="list-style-type: none"> ✓ JRTR's NTD-Si project is structured to meet global demand gaps ✓ While developing local technical expertise and industrial progress
Ultimate Goal	<ul style="list-style-type: none"> ✓ By providing a reliable, high-quality irradiation service ✓ JRTR-NTD facility will enhance Jordan's role in the semiconductor supply chain ✓ Support long-term economic diversification

❖ Summary of NTD Progress

- Serious Plans for entering the NTD **Market** soon.
- Discussing with **Partners**.
- Collecting NTD **Proposals**:
 - ✓ Descriptive
 - ✓ Technical
 - ✓ Financial
- **Stakeholders**.
- **Manpower**.
- **Funding**.



THANK YOU ありがとう شكراً

Together for the prosperity
of RR Utilization

